



STTA2512P STTA5012TV1/2

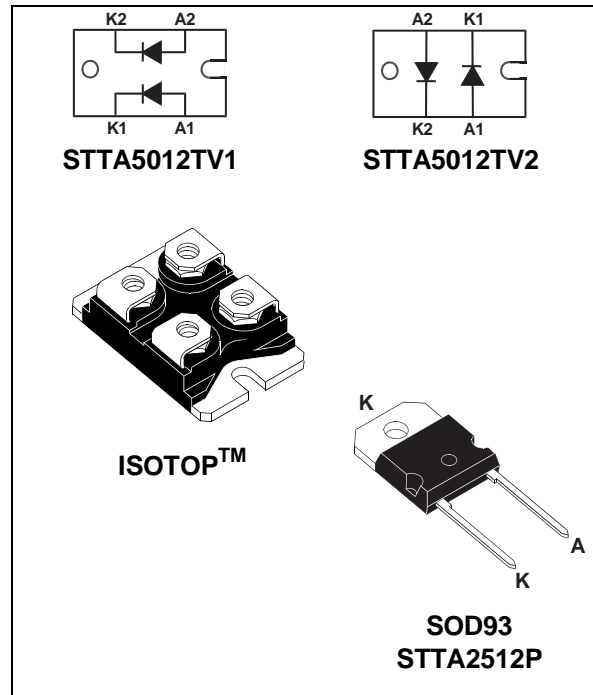
TURBOSWITCH™ ULTRA-FAST HIGH VOLTAGE DIODE

MAIN PRODUCT CHARACTERISTICS

| | |
|----------------|--------------|
| $I_{F(AV)}$ | 25A |
| V_{RRM} | 1200V |
| $t_{rr} (typ)$ | 60ns |
| $V_F (max)$ | 1.9V |

FEATURES AND BENEFITS

- ULTRA-FAST, SOFT RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY AND/OR HIGH PULSED CURRENT OPERATION.
- HIGH REVERSE VOLTAGE CAPABILITY.
- LOW INDUCTANCE PACKAGE < 5 nH.
- INSULATED PACKAGE : ISOTOP™
Electrical insulation : 2500V_{RMS}
Capacitance : < 45pF.



DESCRIPTION

TURBOSWITCH 1200V drastically cuts losses in all high voltage operations which require extremely fast, soft and noise-free power diodes. Due to their optimized switching performances they also highly decrease power losses in any associated switching IGBT or MOSFET in all freewheel mode

operations. They are particularly suitable in Motor Control circuitries, or in the primary of SMPS as snubber, clamping or demagnetizing diodes. They are also suitable for secondary of SMPS as high voltage rectifier diodes.

ABSOLUTE RATINGS (limiting values, per diode)

| Symbol | Parameter | | Value | Unit |
|--------------|--|-----------------------------------|---------------|------|
| V_{RRM} | Repetitive peak reverse voltage | | 1200 | V |
| $I_{F(RMS)}$ | RMS forward current | | 50 | A |
| I_{FRM} | Repetitive peak forward current | $t_p = 5 \mu s$ $F = 5kHz$ square | 300 | A |
| I_{FSM} | Surge non repetitive forward current | $t_p = 10ms$ sinusoidal | 210 | A |
| T_{stg} | Storage temperature range | | - 65 to + 150 | °C |
| T_j | Maximum operating junction temperature | | 150 | °C |

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THERMAL AND POWER DATA (per diode)

| Symbol | Parameter | Conditions | Value | Unit | |
|----------------------|--|------------|-----------------------|------|------|
| R _{th(j-c)} | Junction to case thermal resistance | ISOTOP | Per diode | 1.4 | °C/W |
| | | ISOTOP | Total | 0.75 | |
| | | SOD93 | | 1.2 | |
| R _{th(c)} | Coupling thermal resistance | ISOTOP | Coupling | 0.1 | °C/W |
| P ₁ | Conduction power dissipation I _{F(AV)} = 25A δ = 0.5 | ISOTOP | T _c = 70°C | 57 | W |
| | | SOD93 | T _c = 82°C | | |
| P _{max} | Total power dissipation P _{max} = P ₁ + P ₃ (P ₃ = 10% P ₁) | ISOTOP | T _c = 62°C | 62.5 | W |
| | | SOD93 | T _c = 75°C | | |

STATIC ELECTRICAL CHARACTERISTICS (per diode)

| Symbol | Parameter | Test conditions | | Min | Typ | Max | Unit |
|-------------------|-------------------------|--|------------------------|-----|-----|------|------|
| V _F * | Forward voltage drop | I _F = 25A | T _j = 25°C | | | 2.1 | V |
| | | | T _j = 125°C | | 1.3 | 1.9 | V |
| I _R ** | Reverse leakage current | V _R = 0.8 x V _{RRM} | T _j = 25°C | | | 150 | μA |
| | | | T _j = 125°C | | 2.0 | 8 | mA |
| V _{to} | Threshold voltage | I _p < 3.I _{F(AV)} | T _j = 125°C | | | 1.52 | V |
| R _d | Dynamic resistance | | | | | 15 | mΩ |

Test pulses : * t_p = 380 μs, δ < 2%

** t_p = 5 ms, δ < 2%

To evaluate the maximum conduction losses use the following equation :

$$P = V_{to} \times I_{F(AV)} + R_d \times I_{F(RMS)}^2$$

DYNAMIC ELECTRICAL CHARACTERISTICS (per diode)

TURN-OFF SWITCHING

| Symbol | Parameter | Test conditions | Min | Typ | Max | Unit |
|-----------------|----------------------------------|--|-----|-----|-----|------|
| t _{rr} | Reverse recovery time | T _j = 25°C I _F = 0.5 A I _R = 1A I _{rr} = 0.25A I _F = 1 A dI _F /dt = -50A/μs V _R = 30V | | 60 | 110 | ns |
| I _{RM} | Maximum reverse recovery current | T _j = 125°C V _R = 600V I _F = 25A dI _F /dt = -200 A/μs dI _F /dt = -500 A/μs | | 45 | 35 | A |
| S factor | Softness factor | T _j = 125°C V _R = 600V I _F = 25A dI _F /dt = -500 A/μs | | 1.2 | | / |

TURN-ON SWITCHING

| Symbol | Parameter | Test conditions | Min | Typ | Max | Unit |
|-----------------|-----------------------|---|-----|-----|-----|------|
| t _{fr} | Forward recovery time | T _j = 25°C I _F = 25 A, dI _F /dt = 200 A/μs measured at 1.1 x V _{Fmax} | | | 900 | ns |
| V _{Fp} | Peak forward voltage | T _j = 25°C I _F = 25A, dI _F /dt = 200 A/μs I _F = 40A, dI _F /dt = 500 A/μs | | 35 | 30 | V |

Fig. 1: Conduction losses versus average current (per diode).

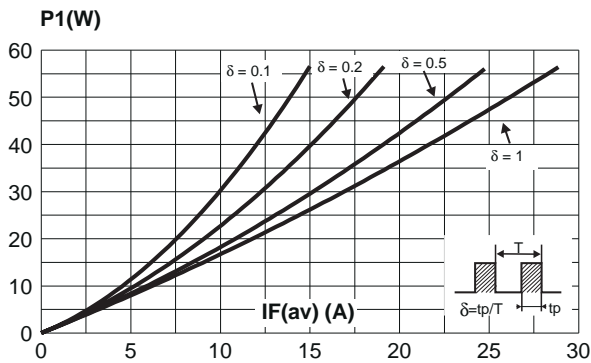


Fig. 2: Forward voltage drop versus forward current (maximum values, per diode).

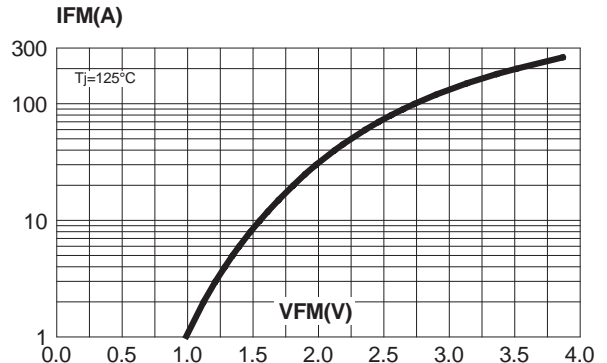


Fig. 3-1: Relative variation of thermal impedance junction to case versus pulse duration (per diode) (ISOTOP).

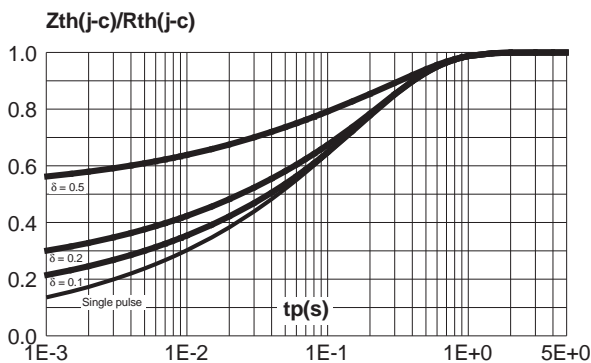


Fig. 3-2: Relative variation of thermal impedance junction to case versus pulse duration (SOD93).

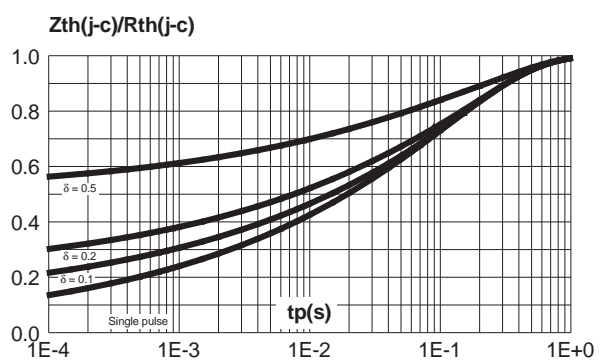


Fig. 4: Peak reverse recovery current versus dI_F/dt (90% confidence, per diode).

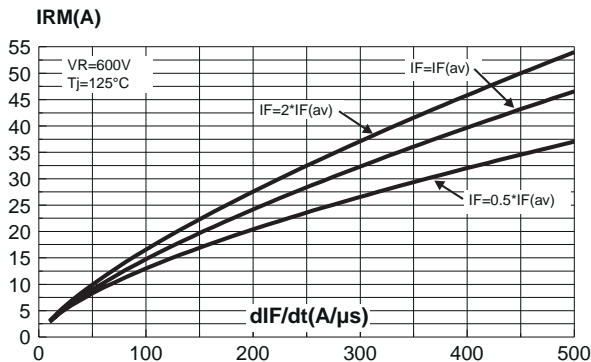


Fig. 5: Reverse recovery time versus dI_F/dt (90% confidence, per diode).

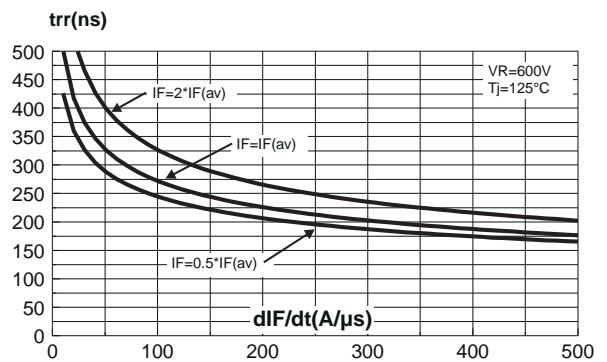


Fig. 6: Softness factor (t_b/t_a) versus dI_F/dt (typical values, per diode).

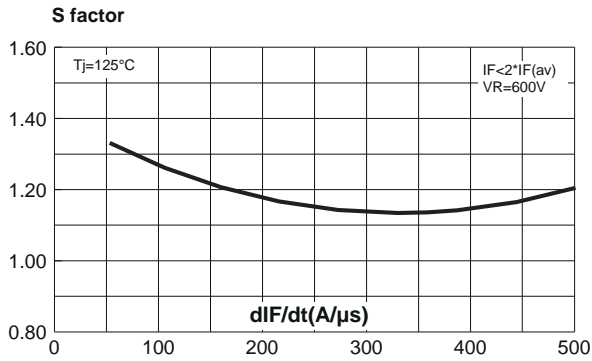


Fig. 7: Relative variation of dynamic parameters versus junction temperature (reference $T_j = 125^\circ C$).

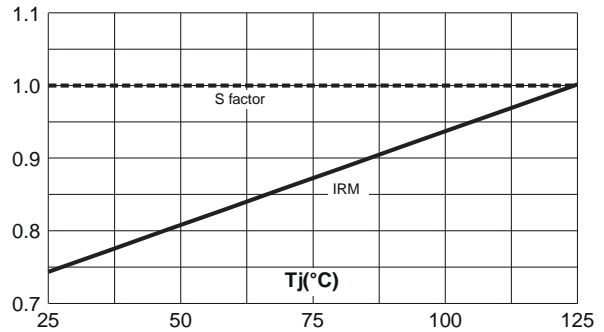


Fig. 8: Transient peak forward voltage versus dI_F/dt (90% confidence, per diode).

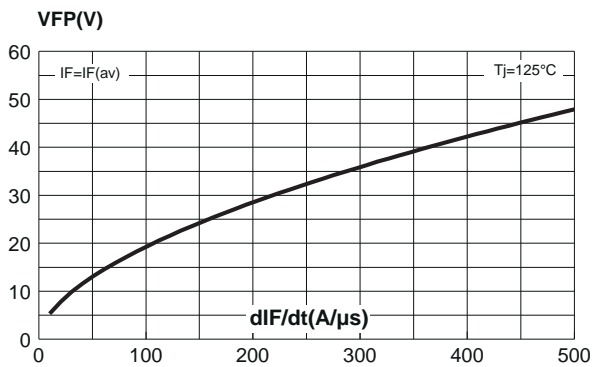
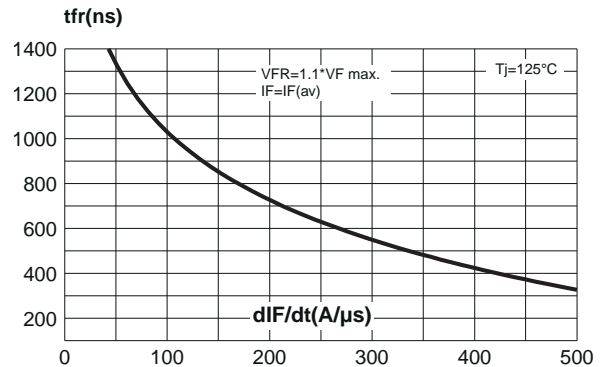


Fig. 9: Forward recovery time versus dI_F/dt (90% confidence, per diode).



APPLICATION DATA

The 1200V TURBOSWITCH series has been designed to provide the lowest overall power losses in all high frequency or high pulsed current operations. In such applications (Fig A to D), the way of calculating the power losses is given below :

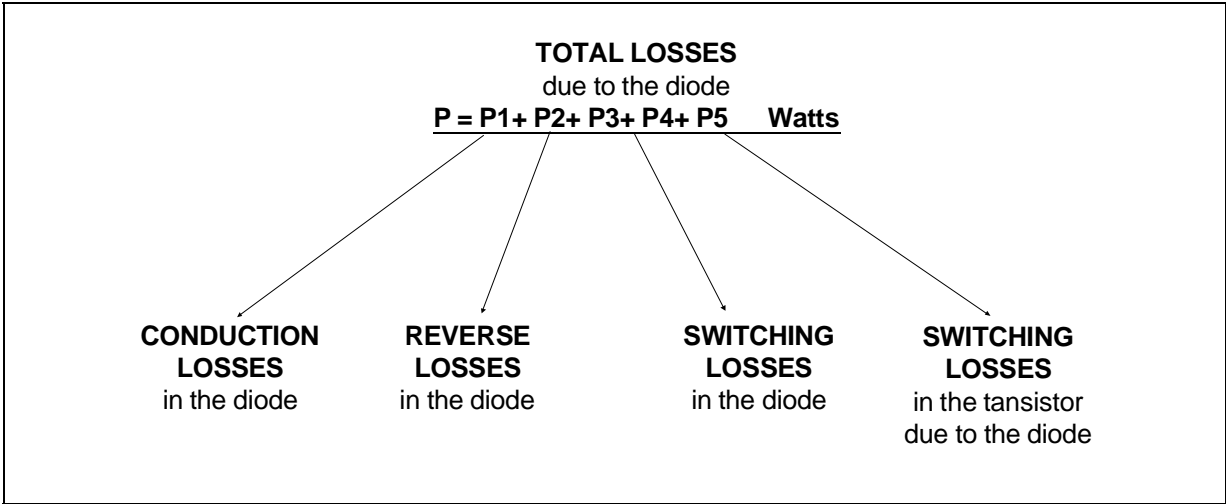


Fig. A : "FREEWHEEL" MODE.

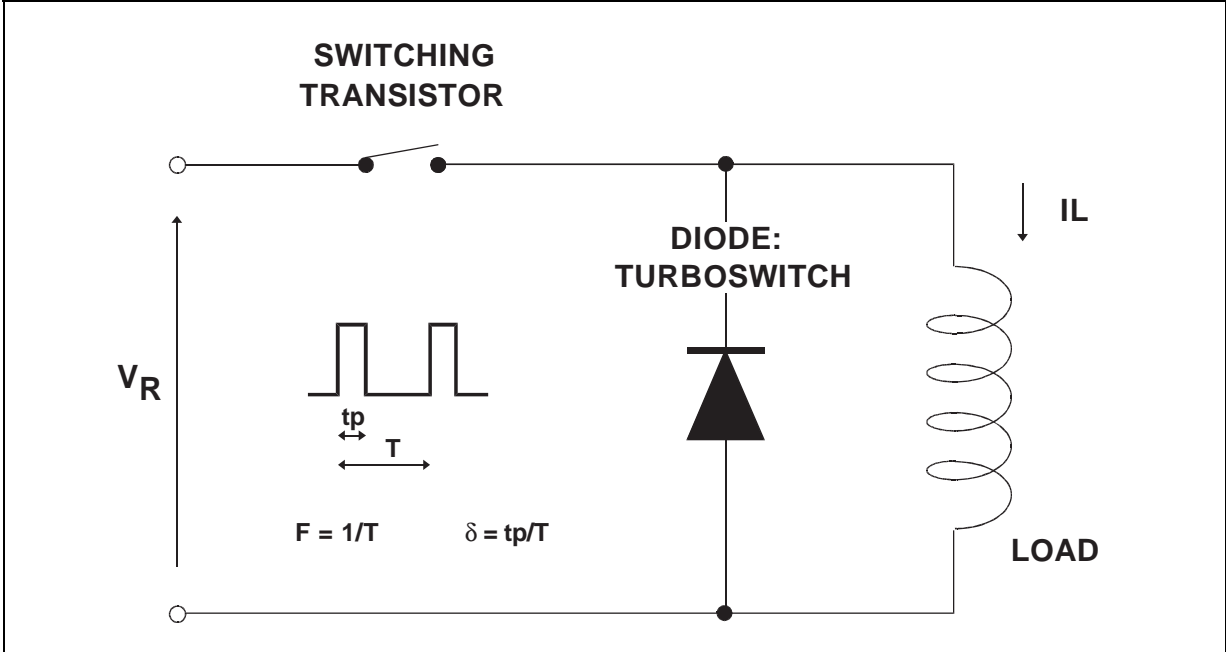


Fig. B : SNUBBER DIODE.

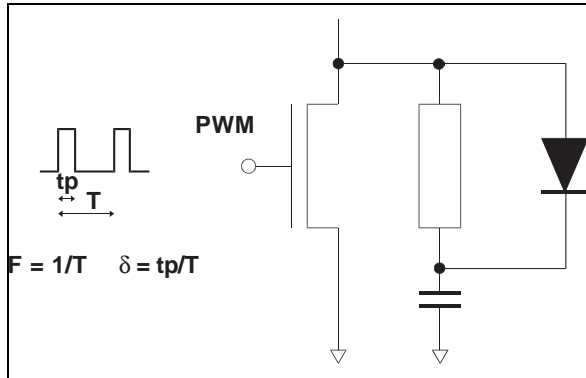


Fig. C : DEMAGNETIZING DIODE.

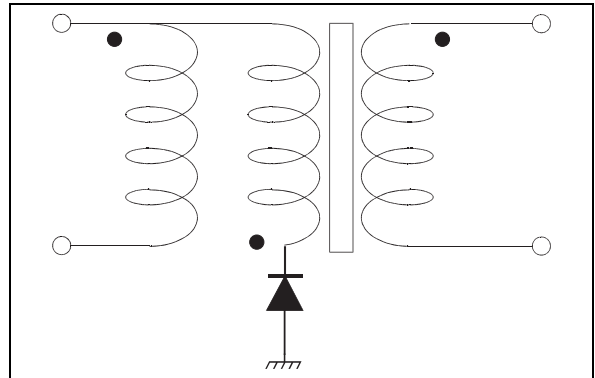
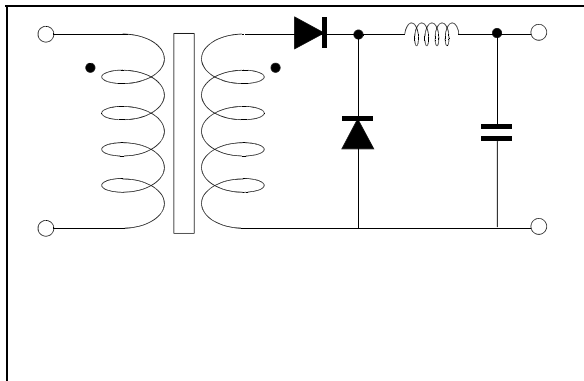
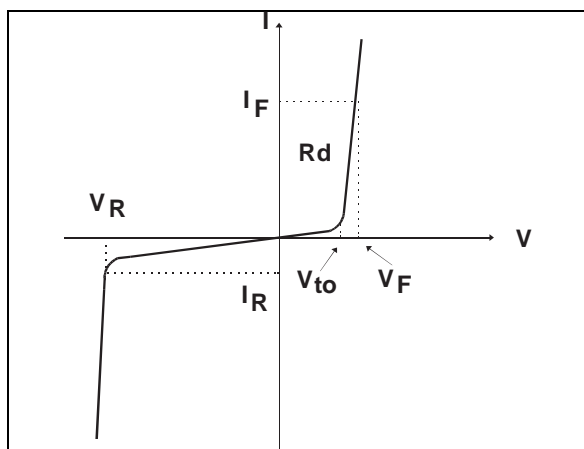


Fig. D : RECTIFIER DIODE.



STATIC & DYNAMIC CHARACTERISTICS . POWER LOSSES .

Fig. E: STATIC CHARACTERISTICS



Conduction losses :

$$P1 = V_{to} \cdot I_{F(AV)} + R_d \cdot I_{F(RMS)}^2$$

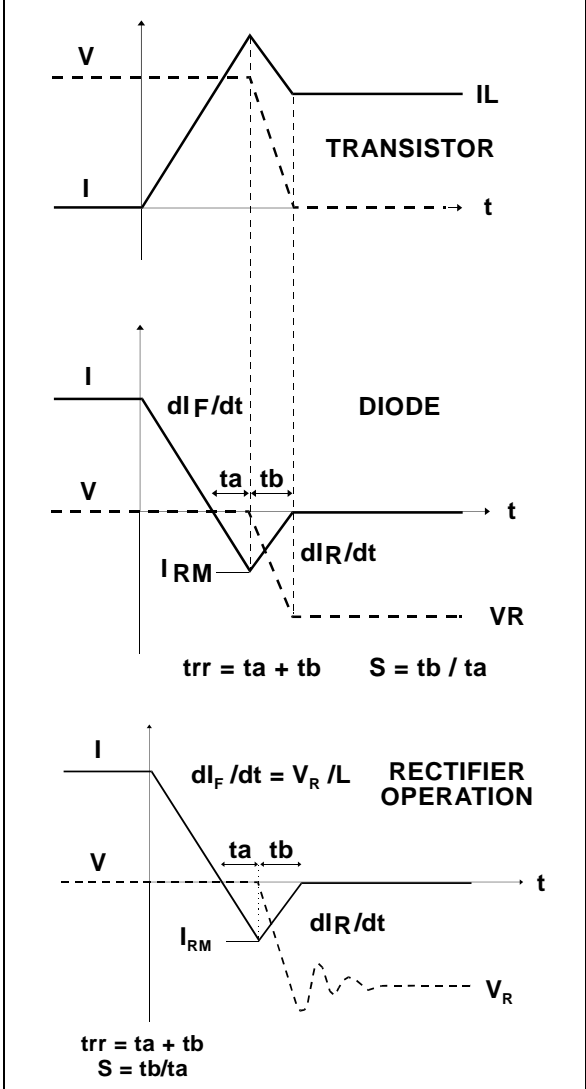
Max values at 125°C, suitable for $I_{peak} < 3 \cdot I_{F(av)}$

Reverse losses :

$$P2 = V_R \cdot I_R \cdot (1 - \delta)$$

APPLICATION DATA (Cont'd)

Fig. F: TURN-OFF CHARACTERISTICS



Turn-on losses :
(in the transistor, due to the diode)

$$P5 = \frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F/dt}$$

Turn-off losses (in the diode) :

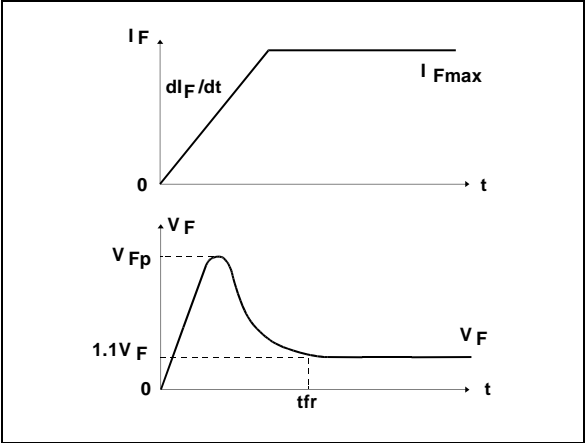
$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

Turn-off losses :
(with non negligible serial inductance)

$$P3' = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt} + \frac{L \times I_{RM}^2 \times F}{2}$$

P3,P3' and P5 are suitable for power MOSFET and IGBT

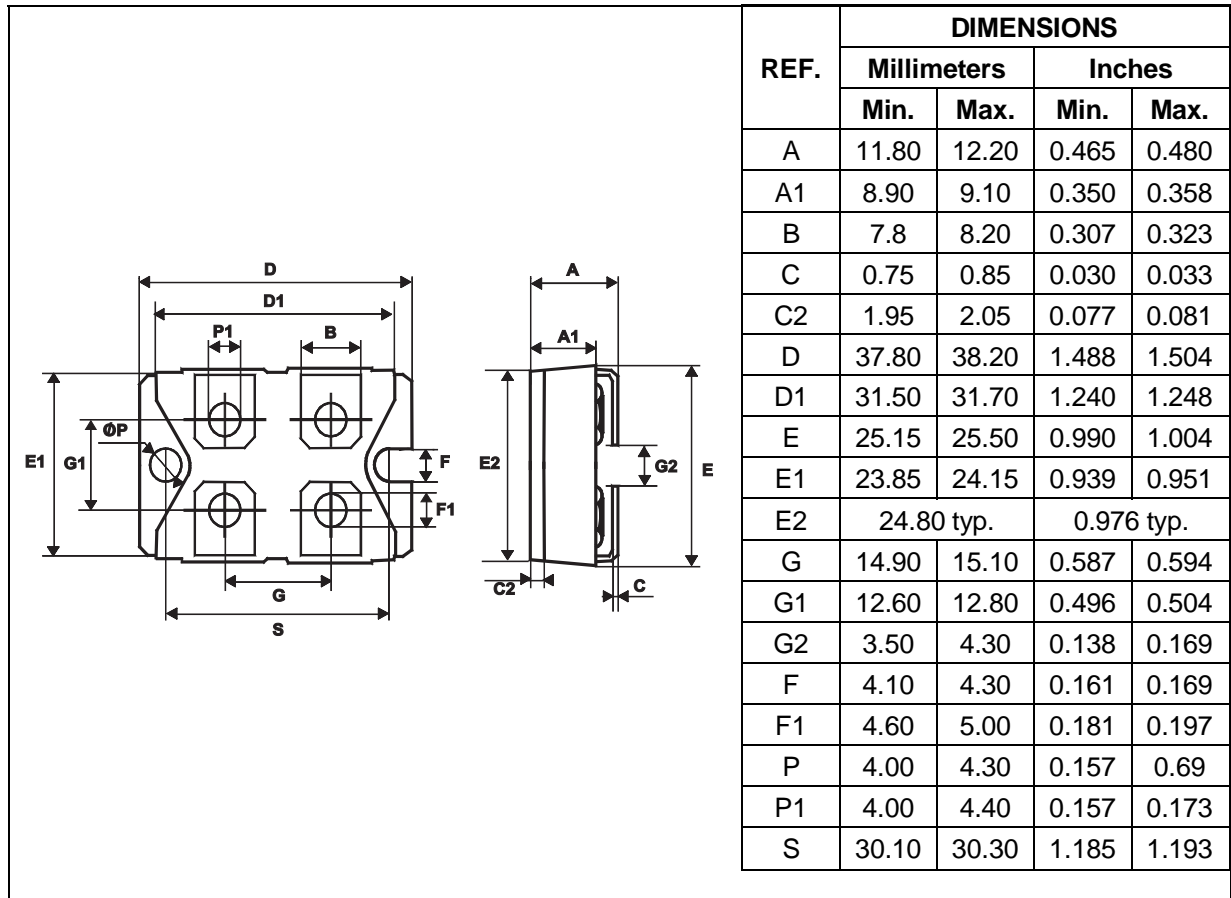
Fig. G: TURN-ON CHARACTERISTICS



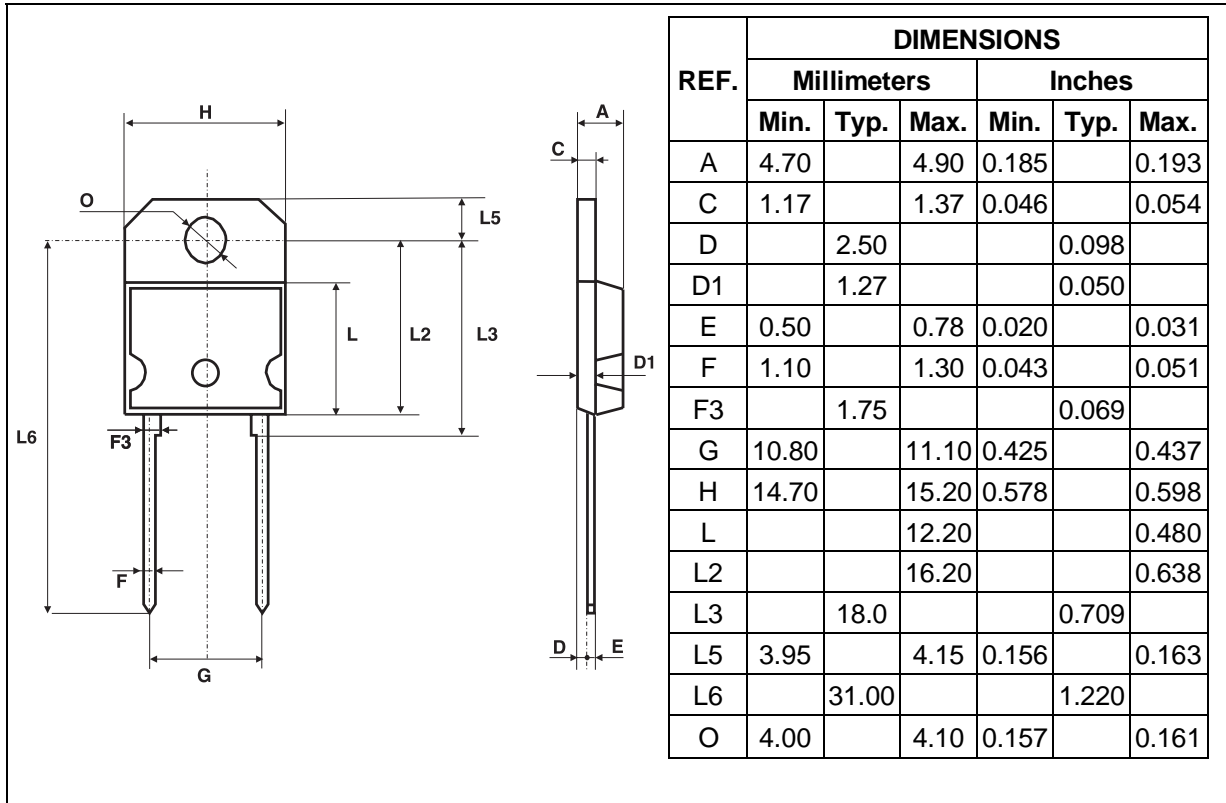
Turn-on losses :
 $P4 = 0.4 (V_{FP} - V_F) \cdot I_{Fmax} \cdot t_{tr} \cdot F$

STTA2512P / STTA5012TV1/2

PACKAGE MECHANICAL DATA
ISOTOP



PACKAGE MECHANICAL DATA
SOD93



| Ordering type | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|-------------|---------|------------------------|----------|---------------|
| STTA5012TV1 | STTA5012TV1 | ISOTOP | 27g. without screws | 10 | Tube |
| STTA5012TV2 | STTA5012TV2 | ISOTOP | | 10 | Tube |
| STTA2512P | STTA2512P | SOD93 | 3.79g. | 30 | Tube |

- Cooling method: by conduction (C)
- ISOTOP recommended torque value: 1.3 N.m. (MAX 1.5 N.m.) for the 6 x M4 screws. (2 x M4 screws recommended for mounting the package on the heatsink and the 4 screws for terminals).
- ISOTOP: the screws supplied with the package are suitable for mounting on a board with a thickness of 0.6 mm min and 2.2 mm max.
- Epoxy meets UL94,V0

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